







an Open Access Journal by MDPI

# Recent Advances in Soft Robotics and Flexible Electronics: From Materials to Applications

Guest Editors:

# Dr. Yongkuk Lee

Department of Biomedical Engineering, Wichita State University, Wichita, KS 67260, USA

## Dr. Woon-Hong Yeo

Woodruff School of Mechanical Engineering, Coulter Department of Biomedical Engineering, Georgia Tech, Atlanta, GA, USA

Deadline for manuscript submissions:

closed (31 July 2023)

# **Message from the Guest Editors**

Dear Colleagues,

In recent years, soft robotics and flexible electronics have been drawing significant attention from many different fields ranging from actuators, healthcare, wearables, human-machine interfaces, and sensors and as they can provide new solutions that were not possible with traditional rigid robotics and electronics such as dexterity. miniaturization, wearability, multi-functionality, deformability. Furthermore, lightweight, soft, and flexible electronics often offer conformal contact with the human body for reliable, accurate, and portable health monitoring or diagnosis in real time. However, to develop such unusual forms of robotics and electronics, advanced interdisciplinary studies and experiments involving biology, chemistry, material sciences, mechanics, and electronics are essential. This Special Issue covers a broad range of topics on recent advancements in the field of soft robotics and flexible electronics from their novel materials, design, manufacturing techniques, and strategies in designing soft/flexible mechanisms to their practical applications.













an Open Access Journal by MDPI

# **Editor-in-Chief**

#### Prof. Dr. Ai-Qun Liu

1. Department of Electrical and Electronic Engineering, The Hong Kong Polytechnic University, Hong Kong, China 2. School of Electrical and Electronic Engineering, Nanyang Technological University, Singapore 639798, Singapore

# **Message from the Editor-in-Chief**

You are invited to contribute research articles or comprehensive reviews for consideration and publication in *Micromachines* (ISSN 2072-666X). *Micromachines* is published in the open access format. Research articles, reviews and other contents are released on the internet immediately after acceptance. The scientific community and the general public have unlimited free access to the content as soon as it is published. As an open access journal, *Micromachines* is supported by the authors or their institutes by payment of article processing charges (APC) for accepted papers. We are pleased to welcome you as our authors.

## **Author Benefits**

**Open Access:** free for readers, with article processing charges (APC) paid by authors or their institutions.

**High Visibility:** indexed within Scopus, SCIE (Web of Science), PubMed, PMC, Ei Compendex, dblp, and other databases.

**Journal Rank:** JCR - Q2 (Instruments and Instrumentation) / CiteScore - Q1 (Mechanical Engineering)

#### **Contact Us**